

Reference-Name : RMS308NA-008

PCB Layer structure	PCB層構造(Japanese)	File Name
TOP Silkscreen	Top Silk	RMS308NA-008 -Top_Silk.phd
Top Resist	Top Resist	RMS308NA-008 -Top_Mask.phd
Top Layer	Top Metal (M1)	RMS308NA-008 -Top_Layer.phd
Bottom Layer	Bottom Metal (M4)	RMS308NA-008 -Bottom_Layer.phd
Bottom Resist	Bottom Resist	RMS308NA-008 -Bottom_Mask.phd
Bottom Silkscreen	Bottom Silk	RMS308NA-008 -Bottom_Silk.phd
PCB Out-line	基板外形	RMS308NA-008 -Outline.phd
Plated Through Hole	メッキ穴	RMS308NA-008 -Drill_PTH.drd
Non-Plated Through Hole	メッキ無穴	RMS308NA-008 -Drill_NPTH.drd
Drill Data	Drill Data	RMS308NA-008 -Drill.drl
HOLE Data	HOLE Data	RMS308NA-008 -HOLE.phd